<table>
<thead>
<tr>
<th>Quantity</th>
<th>Designator</th>
<th>Value</th>
<th>Description</th>
<th>Manufacturer</th>
<th>Manufacturer PN</th>
<th>DigiKeyPartNumber</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>1</td>
<td>U1</td>
<td>OPA365</td>
<td>Texas Instruments</td>
<td>OPA365AID</td>
<td>296-21235-5-ND</td>
</tr>
</tbody>
</table>
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